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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	20MHz
Connectivity	I²C, SPI
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	15
Program Memory Size	7KB (4K x 14)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	4V ~ 5.5V
Data Converters	A/D 6x12b
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	20-SSOP (0.209", 5.30mm Width)
Supplier Device Package	20-SSOP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16c771-ss

2.2.2.1 STATUS REGISTER

The STATUS register, shown in Register 2-1, contains the arithmetic status of the ALU, the RESET status and the bank select bits for data memory.

The STATUS register can be the destination for any instruction, as with any other register. If the STATUS register is the destination for an instruction that affects the Z, DC or C bits, then the write to these three bits is disabled. These bits are set or cleared according to the device logic. Furthermore, the $\overline{TO}$ and $\overline{PD}$ bits are not writable. Therefore, the result of an instruction with the STATUS register as destination may be different than intended.

For example, `CLRF STATUS` will clear the upper-three bits and set the Z bit. This leaves the STATUS register as `000u u1uu` (where `u` = unchanged).

It is recommended, therefore, that only `BCF`, `BSF`, `SWAPF` and `MOVWF` instructions are used to alter the STATUS register, because these instructions do not affect the Z, C or DC bits from the STATUS register. For other instructions not affecting any status bits, see the "Instruction Set Summary."

Note:	The C and DC bits operate as a $\overline{\text{borrow}}$ and digit $\overline{\text{borrow}}$ bit, respectively, in subtraction. See the SUBLW and SUBWF instructions for examples.

REGISTER 2-1: STATUS REGISTER (STATUS: 03h, 83h, 103h, 183h)

R/W-0	R/W-0	R/W-0	R-1	R-1	R/W-x	R/W-x	R/W-x
IRP	RP1	RP0	$\overline{TO}$	$\overline{PD}$	Z	DC	C
bit 7							bit 0

bit 7 **IRP:** Register Bank Select bit (used for indirect addressing)
`1` = Bank 2, 3 (100h - 1FFh)
`0` = Bank 0, 1 (00h - FFh)

bit 6-5 **RP<1:0>:** Register Bank Select bits (used for direct addressing)
`11` = Bank 3 (180h - 1FFh)
`10` = Bank 2 (100h - 17Fh)
`01` = Bank 1 (80h - FFh)
`00` = Bank 0 (00h - 7Fh)
Each bank is 128 bytes

bit 4 **$\overline{TO}$:** Time-out bit
`1` = After power-up, `CLRWDT` instruction, or `SLEEP` instruction
`0` = A WDT time-out occurred

bit 3 **$\overline{PD}$:** Power-down bit
`1` = After power-up or by the `CLRWDT` instruction
`0` = By execution of the `SLEEP` instruction

bit 2 **Z:** Zero bit
`1` = The result of an arithmetic or logic operation is zero
`0` = The result of an arithmetic or logic operation is not zero

bit 1 **DC:** Digit carry/$\overline{\text{borrow}}$ bit (`ADDWF`, `ADDLW`, `SUBLW`, `SUBWF` instructions) (for $\overline{\text{borrow}}$ the polarity is reversed)
`1` = A carry-out from the 4th low order bit of the result occurred
`0` = No carry-out from the 4th low order bit of the result

bit 0 **C:** Carry/$\overline{\text{borrow}}$ bit (`ADDWF`, `ADDLW`, `SUBLW`, `SUBWF` instructions)
`1` = A carry-out from the Most Significant bit of the result occurred
`0` = No carry-out from the Most Significant bit of the result occurred

Note: For $\overline{\text{borrow}}$, the polarity is reversed. A subtraction is executed by adding the two's complement of the second operand. For rotate (`RRF`, `RLF`) instructions, this bit is loaded with either the high or low order bit of the source register.

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
- n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

2.2.2.4 PIE1 REGISTER

This register contains the individual enable bits for the peripheral interrupts.

Note: Bit PEIE (INTCON<6>) must be set to enable any peripheral interrupt.

REGISTER 2-4: PERIPHERAL INTERRUPT ENABLE REGISTER 1 (PIE1: 8Ch)

U-0	R/W-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
—	ADIE	—	—	SSPIE	CCP1IE	TMR2IE	TMR1IE
bit 7							bit 0

bit 7 **Unimplemented:** Read as ’0’

bit 6 **ADIE:** A/D Converter Interrupt Enable bit
1 = Enables the A/D interrupt
0 = Disables the A/D interrupt

bit 5-4 **Unimplemented:** Read as ’0’

bit 3 **SSPIE:** Synchronous Serial Port Interrupt Enable bit
1 = Enables the SSP interrupt
0 = Disables the SSP interrupt

bit 2 **CCP1IE:** CCP1 Interrupt Enable bit
1 = Enables the CCP1 interrupt
0 = Disables the CCP1 interrupt

bit 1 **TMR2IE:** TMR2 to PR2 Match Interrupt Enable bit
1 = Enables the TMR2 to PR2 match interrupt
0 = Disables the TMR2 to PR2 match interrupt

bit 0 **TMR1IE:** TMR1 Overflow Interrupt Enable bit
1 = Enables the TMR1 overflow interrupt
0 = Disables the TMR1 overflow interrupt

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
- n = Value at POR	’1’ = Bit is set	’0’ = Bit is cleared	x = Bit is unknown

NOTES:

NOTES:

REGISTER 9-3: SYNC SERIAL PORT CONTROL REGISTER2 (SSPCON2: 91h)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN
bit 7							bit 0

bit 7 **GCEN:** General Call Enable bit (In I^2C Slave mode only)
1 = Enable interrupt when a general call address (0000h) is received in the SSPSR.
0 = General call address disabled.

bit 6 **ACKSTAT:** Acknowledge Status bit (In I^2C Master mode only)
In Master Transmit mode:
1 = Acknowledge was not received from slave
0 = Acknowledge was received from slave

bit 5 **ACKDT:** Acknowledge Data bit (In I^2C Master mode only)
In Master Receive mode:
Value that will be transmitted when the user initiates an Acknowledge sequence at the end of a receive.
1 = Not Acknowledge (NACK)
0 = Acknowledge (ACK)

bit 4 **ACKEN:** Acknowledge Sequence Enable bit (In I^2C Master mode only).
In Master Receive mode:
1 = Initiate Acknowledge sequence on SDA and SCL pins, and transmit ACKDT data bit. Automatically cleared by hardware.
0 = Acknowledge sequence IDLE

bit 3 **RCEN:** Receive Enable bit (In I^2C Master mode only).
1 = Enables Receive mode for I^2C
0 = Receive IDLE

bit 2 **PEN:** STOP Condition Enable bit (In I^2C Master mode only).
SCK Release Control
1 = Initiate STOP condition on SDA and SCL pins. Automatically cleared by hardware.
0 = STOP condition IDLE

bit 1 **RSEN:** Repeated START Condition Enabled bit (In I^2C Master mode only)
1 = Initiate Repeated START condition on SDA and SCL pins. Automatically cleared by hardware.
0 = Repeated START condition IDLE

bit 0 **SEN:** START Condition Enabled bit (In I^2C Master mode only)
1 = Initiate START condition on SDA and SCL pins. Automatically cleared by hardware.
0 = START condition IDLE

Note: For bits ACKEN, RCEN, PEN, RSEN, SEN: If the I^2C module is not in the IDLE mode, this bit may not be set (no spooling) and the SSPBUF may not be written (or writes to the SSPBUF are disabled).

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
- n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

9.1 SPI Mode

The SPI mode allows eight bits of data to be synchronously transmitted and received simultaneously. All four modes of SPI are supported. To accomplish communication, typically three pins are used:

- Serial Data Out (SDO)
- Serial Data In (SDI)
- Serial Clock (SCK)

Additionally, a fourth pin may be used when in a Slave mode of operation:

- Slave Select ($\overline{SS}$)

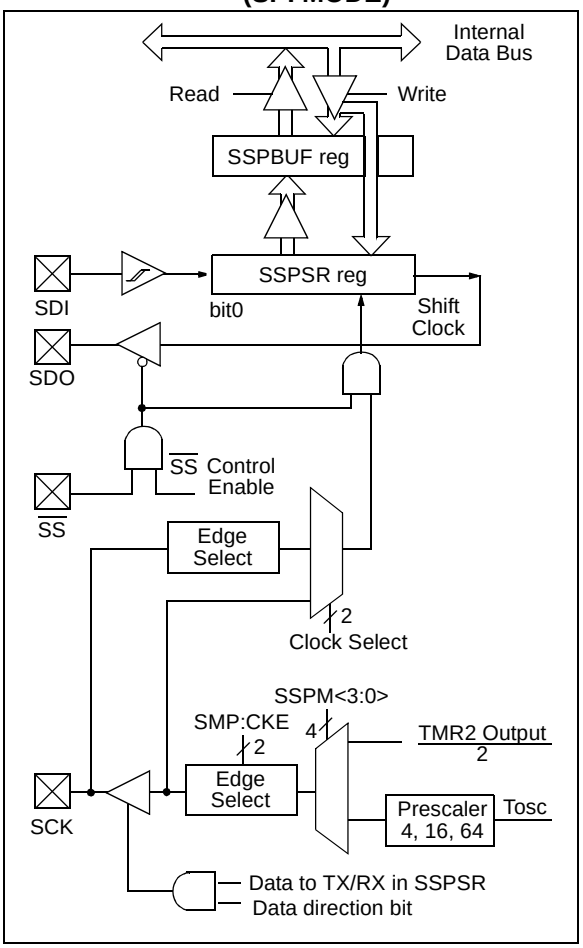
9.1.1 OPERATION

When initializing the SPI, several options need to be specified. This is done by programming the appropriate control bits (SSPCON<5:0> and SSPSTAT<7:6>). These control bits allow the following to be specified:

- Master Mode (SCK is the clock output)
- Slave Mode (SCK is the clock input)
- Clock Polarity (Idle state of SCK)
- Data input sample phase (middle or end of data output time)
- Clock edge (output data on rising/falling edge of SCK)
- Clock Rate (Master mode only)
- Slave Select Mode (Slave mode only)

Figure 9-1 shows the block diagram of the MSSP module when in SPI mode.

FIGURE 9-1: MSSP BLOCK DIAGRAM (SPI MODE)



The MSSP consists of a transmit/receive Shift Register (SSPSR) and a Buffer Register (SSPBUF). The SSPSR shifts the data in and out of the device, MSb first. The SSPBUF holds the data that was written to the SSPSR, until the received data is ready. Once the eight bits of data have been received, that byte is moved to the SSPBUF register. Then the buffer full detect bit, BF (SSPSTAT<0>), and the interrupt flag bit, SSPIF (PIR1<3>), are set. This double buffering of the received data (SSPBUF) allows the next byte to start reception before reading the data that was just received. Any write to the SSPBUF register during transmission/reception of data will be ignored, and the write collision detect bit WCOL (SSPCON<7>) will be set. User software must clear the WCOL bit so that it can be determined if the following write(s) to the SSPBUF register completed successfully.

9.1.4 MASTER MODE

The master can initiate the data transfer at any time because it controls the SCK. The master determines when the slave (Processor 2, Figure 9-2) is to broadcast data by the software protocol.

In Master mode, the data is transmitted/received as soon as the SSPBUF register is written to. If the SPI module is only going to receive, the SDO output could be disabled (programmed as an input). The SSPSR register will continue to shift in the signal present on the SDI pin at the programmed clock rate. As each byte is received, it will be loaded into the SSPBUF register as if a normal received byte (interrupts and status bits appropriately set). This could be useful in receiver applications as a “line activity monitor”.

The clock polarity is selected by appropriately programming bit CKP (SSPCON<4>). This then would give waveforms for SPI communication as shown in Figure 9-3, Figure 9-5 and Figure 9-6, where the MSb is transmitted first. In Master mode, the SPI clock rate (bit rate) is user programmable to be one of the following:

- FOSC/4 (or TCY)
- FOSC/16 (or 4 • TCY)
- FOSC/64 (or 16 • TCY)
- Timer2 output/2

This allows a maximum bit clock frequency (at 20 MHz) of 8.25 MHz.

Figure 9-3 shows the waveforms for Master mode. When CKE = 1, the SDO data is valid before there is a clock edge on SCK. The change of the input sample is shown based on the state of the SMP bit. The time when the SSPBUF is loaded with the received data is shown.

FIGURE 9-3: SPI MODE WAVEFORM (MASTER MODE)

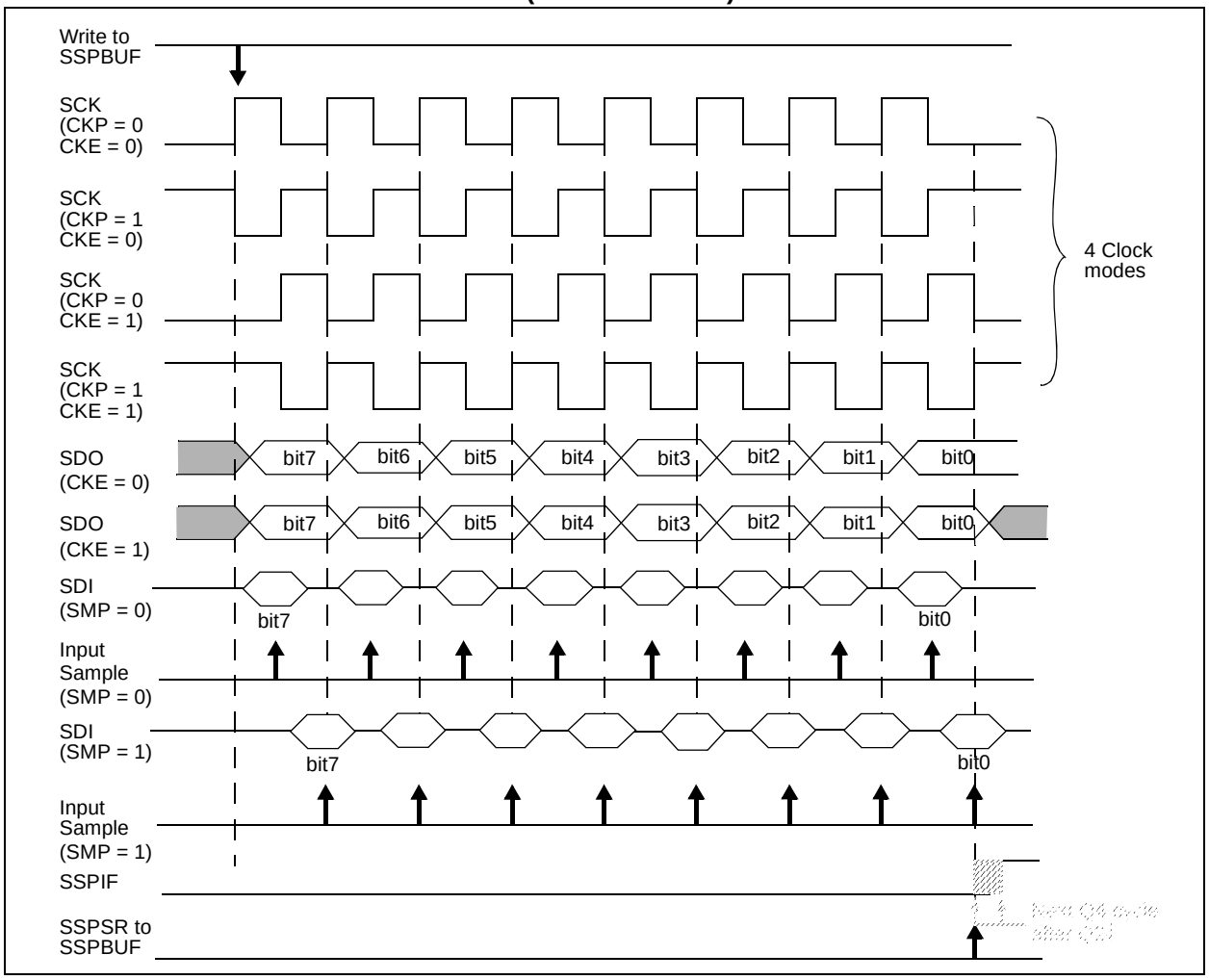


FIGURE 9-18: I²C MASTER MODE WAVEFORMS FOR TRANSMISSION (7 OR 10-BIT ADDRESS)

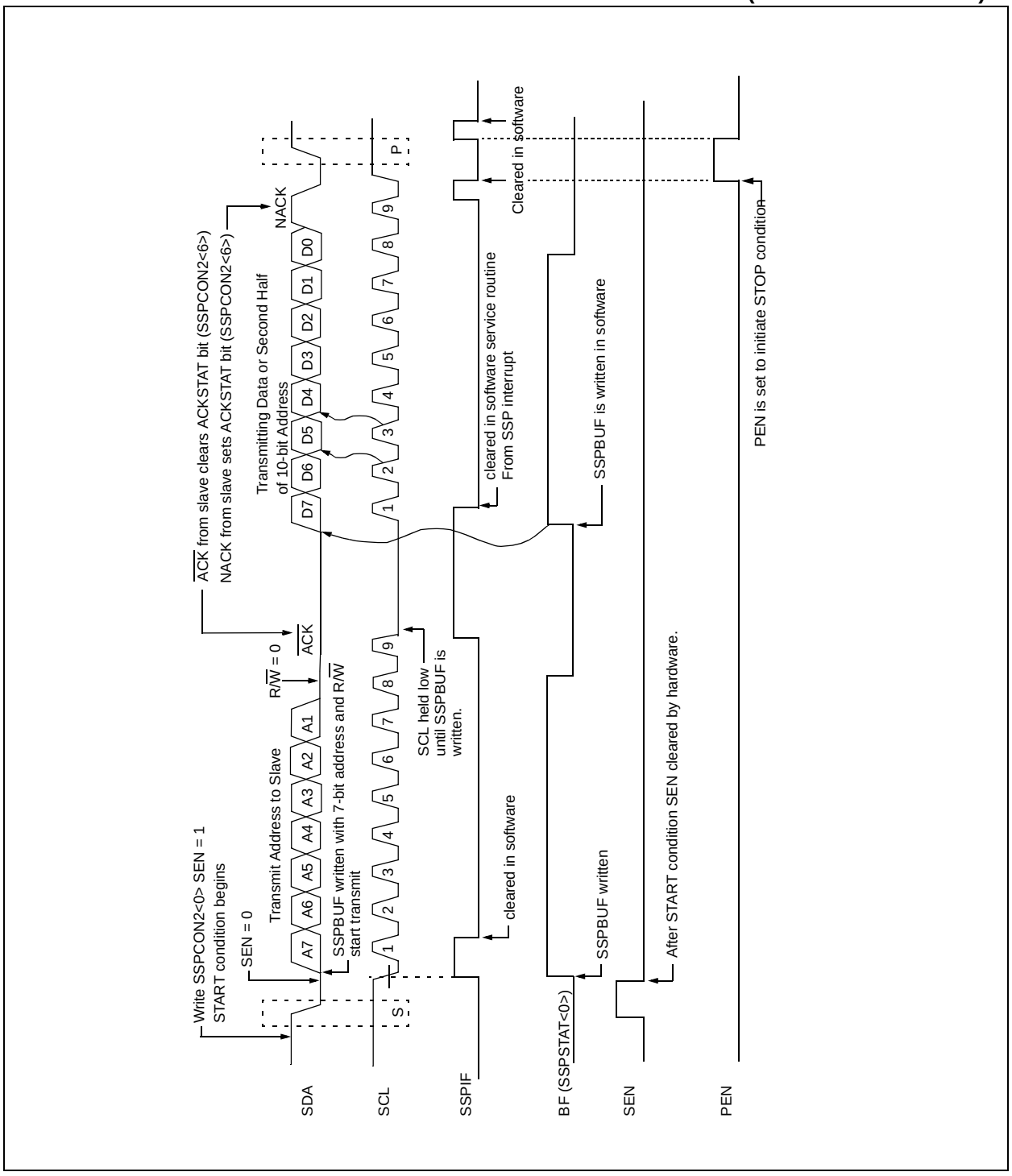
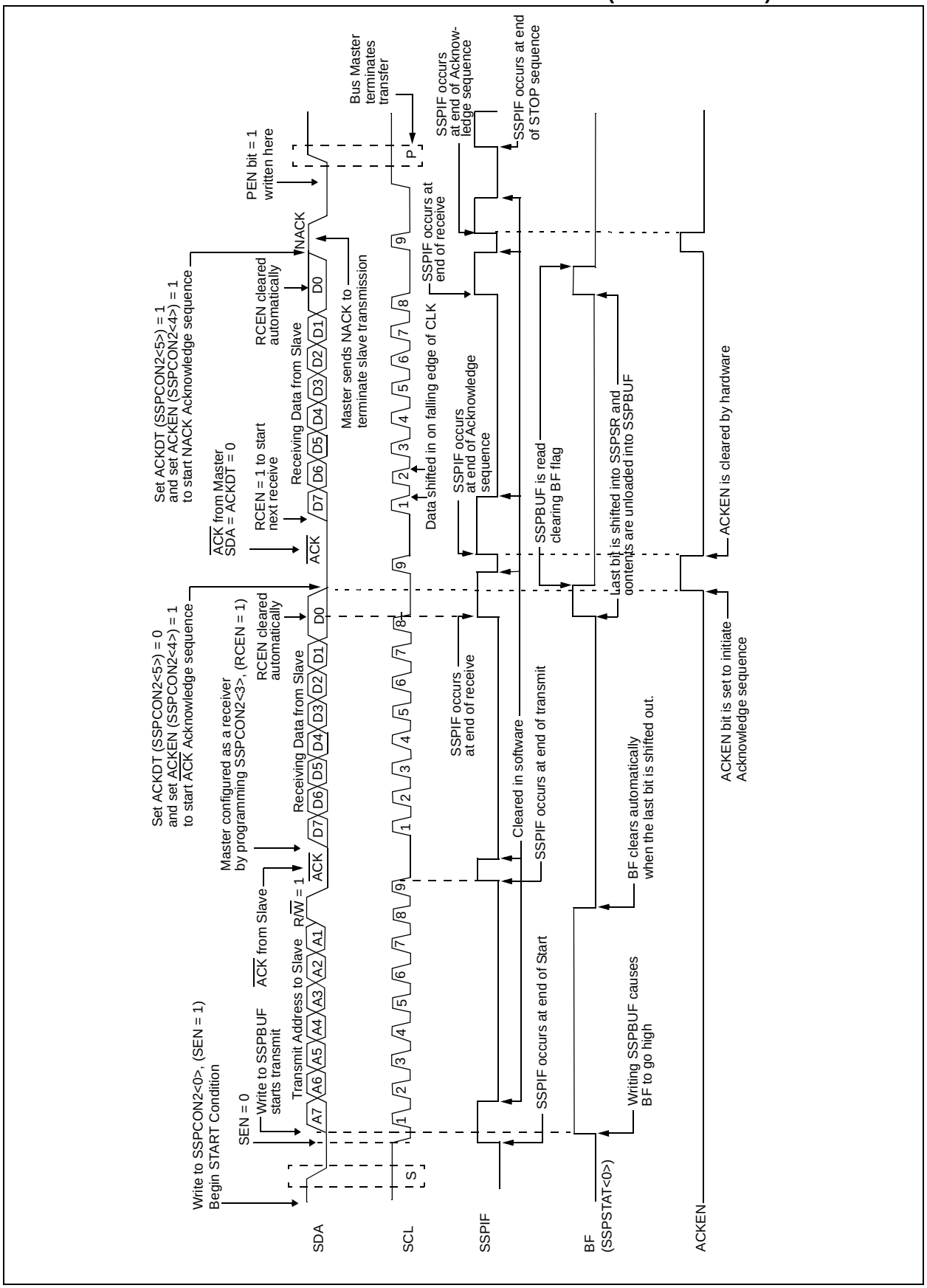


FIGURE 9-19: I²C MASTER WAVEFORMS FOR RECEPTION (7-BIT ADDRESS)



10.3 Low Voltage Detect (LVD)

This module is used to generate an interrupt when the supply voltage falls below a specified “trip” voltage. This module operates completely under software control. This allows a user to power the module on and off to periodically monitor the supply voltage, and thus minimize total current consumption.

The LVD module is enabled by setting the LVDEN bit in the LVDCON register. The “trip point” voltage is the minimum supply voltage level at which the device can operate before the LVD module asserts an interrupt. When the supply voltage is equal to or less than the trip point, the module will generate an interrupt signal setting interrupt flag bit LVDIF. If interrupt enable bit LVDIE was set, then an interrupt is generated. The LVD interrupt can wake the device from SLEEP. The "trip point" voltage is software programmable to any one of 16 values, five of which are reserved (See Figure 10-1). The trip point is selected by programming the LV<3:0> bits (LVDCON<3:0>).

Note:	The LVDIF bit can not be cleared until the supply voltage rises above the LVD trip point. If interrupts are enabled, clear the LVDIE bit once the first LVD interrupt occurs to prevent reentering the interrupt service routine immediately after exiting the ISR.

Once the LV bits have been programmed for the specified trip voltage, the low-voltage detect circuitry is then enabled by setting the LVDEN (LVDCON<4>) bit.

If the bandgap reference voltage is previously unused by either the brown-out circuitry or the voltage reference circuitry, then the bandgap circuit requires a time to start-up and become stable before a low voltage condition can be reliably detected. The low-voltage interrupt flag is prevented from being set until the bandgap has reached a stable reference voltage.

When the bandgap is stable the BGST (LVDCON<5>) bit is set indicating that the low-voltage interrupt flag bit is released to be set if VDD is equal to or less than the LVD trip point.

10.3.1 EXTERNAL ANALOG VOLTAGE INPUT

The LVD module has an additional feature that allows the user to supply the trip voltage to the module from an external source. This mode is enabled when LV<3:0> = 1111. When these bits are set the comparator input is multiplexed from an external input pin (RA1/AN1/LVDIN).

11.6 A/D Sample Requirements

11.6.1 RECOMMENDED SOURCE IMPEDANCE

The maximum recommended impedance for analog sources is 2.5 kΩ. This value is calculated based on the maximum leakage current of the input pin. The leakage current is 100 nA max., and the analog input voltage cannot be varied by more than 1/4 LSb or 250 μV due to leakage. This places a requirement on the input impedance of 250 μV/100 nA = 2.5 kΩ.

11.6.2 SAMPLING TIME CALCULATION

For the A/D converter to meet its specified accuracy, the charge holding capacitor (CHOLD) must be allowed to fully charge to the input channel voltage level. The analog input model is shown in Figure 11-5. The source impedance (RS) and the internal sampling switch (RSS) impedance directly affect the time required to charge the capacitor CHOLD. The sampling switch (RSS) impedance varies over the device voltage (VDD), see Figure 11-5. **The maximum recommended impedance for analog sources is 2.5 kΩ.** After the analog input channel is selected (changed) this sampling must be done before the conversion can be started.

To calculate the minimum sampling time, Equation 11-2 may be used. This equation assumes that 1/4 LSb error is used (16384 steps for the A/D). The 1/4 LSb error is the maximum error allowed for the A/D to meet its specified resolution.

The CHOLD is assumed to be 25 pF for the 12-bit A/D.

EXAMPLE 11-2: A/D SAMPLING TIME EQUATION

$$V_{HOLD} = V_{REF} - \frac{V_{REF}}{16384}$$

$$V_{REF} - \frac{V_{REF}}{16384} = (V_{REF})\left(1 - e^{\left(\frac{-T_C}{C_{HOLD}(R_{IC} + R_{SS} + R_S)}\right)}\right)$$

$$V_{REF}\left(1 - \frac{1}{16384}\right) = (V_{REF})\left(1 - e^{\left(\frac{-T_C}{C_{HOLD}(R_{IC} + R_{SS} + R_S)}\right)}\right)$$

Solving for TC:

$$T_C = -C_{HOLD}(1k + R_{SS} + R_S)\ln\left(\frac{1}{16384}\right)$$

Figure 11-3 shows the calculation of the minimum time required to charge CHOLD. This calculation is based on the following system assumptions:

CHOLD = 25 pF

RS = 2.5 kΩ

1/4 LSb error

VDD = 5V → RSS = 10 kΩ (worst case)

Temp (system Max.) = 50°C

Note 1: The reference voltage (VREF) has no effect on the equation, since it cancels itself out.

2: The charge holding capacitor (**CHOLD**) is not discharged after each conversion.

3: The maximum recommended impedance for analog sources is 2.5 kΩ. This is required to meet the pin leakage specification.

EXAMPLE 11-3: CALCULATING THE MINIMUM REQUIRED SAMPLE TIME

TACQ = Amplifier Settling Time
+ Holding Capacitor Charging Time
+Temperature offset †

TACQ = 5 µs
+ TC
+ [(Temp - 25°C)(0.05 µs/°C)] †

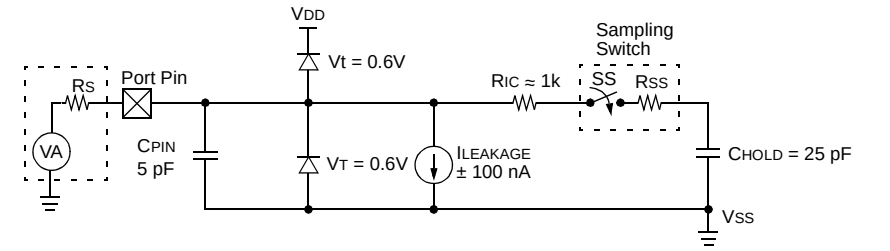
TC = Holding Capacitor Charging Time
TC = (CHOLD) (RIC + RSS + RS) In (1/16384)
TC = -25 pF (1 kΩ +10 kΩ + 2.5 kΩ) In (1/16384)
TC = -25 pF (13.5 kΩ) In (1/16384)
TC = -0.338 (-9.704)µs
TC = 3.3 µs

TACQ = 5 µs
+ 3.3 µs
+ [(50°C - 25°C)(0.05 µs / °C)]

TACQ = 8.3 µs + 1.25 µs
TACQ = 9.55 µs

† The temperature coefficient is only required for temperatures > 25°C.

FIGURE 11-5: ANALOG INPUT MODEL



Legend CPIN = input capacitance
VT = threshold voltage
ILEAKAGE = leakage current at the pin due to various junctions
RIC = interconnect resistance
SS = sampling switch
CHOLD = sample/hold capacitance

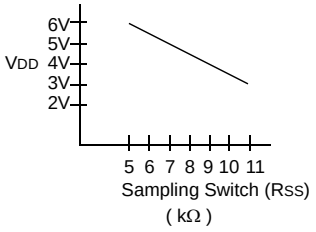


TABLE 12-6: INITIALIZATION CONDITIONS FOR ALL REGISTERS

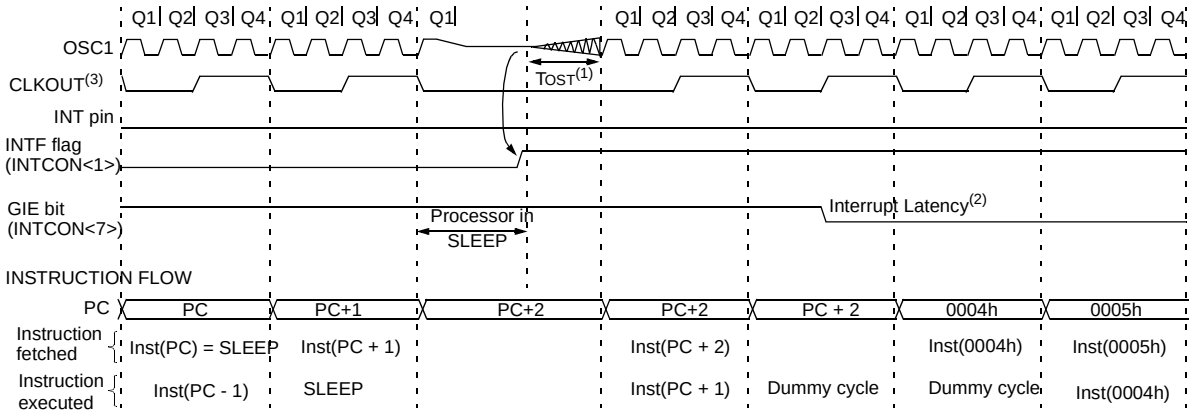
Register	Power-on Reset or Brown-out Reset	$\overline{\text{MCLR}}$ Reset or WDT Reset	Wake-up via WDT or Interrupt
W	xxxx xxxx	uuuu uuuu	uuuu uuuu
INDF	0000 0000	uuuu uuuu	uuuu uuuu
TMR0	xxxx xxxx	uuuu uuuu	uuuu uuuu
PCL	0000h	0000h	PC + 1(1)
STATUS	0001 1xxx	000q quuu(2)	uuuq quuu(2)
FSR	xxxx xxxx	uuuu uuuu	uuuu uuuu
PORTA	xxxx 0000	uuuu 0000	uuuu uuuu
PORTB	xxxx xx11	uuuu uu11	uuuu uuuu
PCLATH	---0 0000	---0 0000	---u uuuu
INTCON	0000 000x	0000 000u	uuuu uuqq
PIR1	-0-- 0000	-0-- 0000	-0-- uuuu
PIR2	0--- 0---	0--- 0---	q--- q---
TMR1L	xxxx xxxx	uuuu uuuu	uuuu uuuu
TMR1H	xxxx xxxx	uuuu uuuu	uuuu uuuu
T1CON	--00 0000	--uu uuuu	--uu uuuu
TMR2	0000 0000	0000 0000	uuuu uuuu
T2CON	-000 0000	-000 0000	-uuu uuuu
SSPBUF	xxxx xxxx	uuuu uuuu	uuuu uuuu
SSPCON	0000 0000	0000 0000	uuuu uuuu
CCPR1L	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCPR1H	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCP1CON	0000 0000	0000 0000	uuuu uuuu
ADRESH	xxxx xxxx	uuuu uuuu	uuuu uuuu
ADCON0	0000 0000	0000 0000	uuuu uuuu
OPTION_REG	1111 1111	1111 1111	uuuu uuuu
TRISA	1111 1111	1111 1111	uuuu uuuu
TRISB	1111 1111	1111 1111	uuuu uuuu
PIE1	-0-- 0000	-0-- 0000	-u-- uuuu
PIE2	0--- 0---	0--- 0---	u--- u---
PCON	---- 1-qq	---- 1-uu	---- u-uu
PR2	1111 1111	1111 1111	1111 1111
SSPADD	0000 0000	0000 0000	uuuu uuuu
SSPSTAT	0000 0000	0000 0000	uuuu uuuu
WPUB	1111 1111	1111 1111	uuuu uuuu
IOCB	1111 0000	1111 0000	uuuu uuuu

Legend: u = unchanged, x = unknown, - = unimplemented bit, read as '0', q = value depends on condition

Note 1: When the wake-up is due to an interrupt and the GIE bit is set, the PC is loaded with the interrupt vector (0004h).

2: See Table 12-5 for RESET value for specific condition.

FIGURE 12-12: WAKE-UP FROM SLEEP THROUGH INTERRUPT



Note 1: TOST = 1024TOSC (drawing not to scale) This delay applies to LP, XT and HS modes only.
2: GIE = '1' assumed. In this case after wake- up, the processor jumps to the interrupt routine. If GIE = '0', execution will continue in-line.
3: CLKOUT is not available in these osc modes, but shown here for timing reference.

12.14 Program Verification/Code Protection

If the code protection bit(s) have not been programmed, the on-chip program memory can be read out for verification purposes.

Note:	Microchip does not recommend code protecting windowed devices. Code protected devices are not reprogrammable.

12.15 ID Locations

Four memory locations (2000h - 2003h) are designated as ID locations where the user can store checksum or other code-identification numbers. These locations are not accessible during normal execution but are readable and writable during program/verify. It is recommended that only the 4 Least Significant bits of the ID location are used.

12.16 In-Circuit Serial Programming (ICSP™)

PIC16CXXX microcontrollers can be serially programmed while in the end application circuit. This is simply done with two lines for clock and data, and three other lines for power, ground, and the programming voltage. This allows customers to manufacture boards with unprogrammed devices, and then program the microcontroller just before shipping the product. This also allows the most recent firmware or a custom firmware to be programmed.

For complete details of serial programming, please refer to the In-Circuit Serial Programming (ICSP™) Guide, (DS30277).

TABLE 13-2: PIC16CXXX INSTRUCTION SET

Mnemonic, Operands		Description	Cycles	14-Bit Opcode MSb	LSb	Status Affected	Notes
BYTE-ORIENTED FILE REGISTER OPERATIONS							
ADDWF	**f, d**	Add W and f	1	00 0111 dfff ffff		C,DC,Z	1,2
ANDWF	**f, d**	AND W with f	1	00 0101 dfff ffff		Z	1,2
CLRF	**f**	Clear f	1	00 0001 lfff ffff		Z	2
CLRW	**-**	Clear W	1	00 0001 0000 0011		Z	
COMF	**f, d**	Complement f	1	00 1001 dfff ffff		Z	1,2
DECF	**f, d**	Decrement f	1	00 0011 dfff ffff		Z	1,2
DECFSZ	**f, d**	Decrement f, Skip if 0	1(2)	00 1011 dfff ffff			1,2,3
INCF	**f, d**	Increment f	1	00 1010 dfff ffff		Z	1,2
INCFSZ	**f, d**	Increment f, Skip if 0	1(2)	00 1111 dfff ffff			1,2,3
IORWF	**f, d**	Inclusive OR W with f	1	00 0100 dfff ffff		Z	1,2
MOVF	**f, d**	Move f	1	00 1000 dfff ffff		Z	1,2
MOVWF	**f**	Move W to f	1	00 0000 lfff ffff			
NOP	**-**	No Operation	1	00 0000 0xx0 0000			
RLF	**f, d**	Rotate Left f through Carry	1	00 1101 dfff ffff		C	1,2
RRF	**f, d**	Rotate Right f through Carry	1	00 1100 dfff ffff		C	1,2
SUBWF	**f, d**	Subtract W from f	1	00 0010 dfff ffff		C,DC,Z	1,2
SWAPF	**f, d**	Swap nybbles in f	1	00 1110 dfff ffff			1,2
XORWF	**f, d**	Exclusive OR W with f	1	00 0110 dfff ffff		Z	1,2
BIT-ORIENTED FILE REGISTER OPERATIONS							
BCF	**f, b**	Bit Clear f	1	01 00bb bfff ffff			1,2
BSF	**f, b**	Bit Set f	1	01 01bb bfff ffff			1,2
BTFSC	**f, b**	Bit Test f, Skip if Clear	1 (2)	01 10bb bfff ffff			3
BTFSS	**f, b**	Bit Test f, Skip if Set	1 (2)	01 11bb bfff ffff			3
LITERAL AND CONTROL OPERATIONS							
ADDLW	**k**	Add literal and W	1	11 111x kkkk kkkk		C,DC,Z	
ANDLW	**k**	AND literal with W	1	11 1001 kkkk kkkk		Z	
CALL	**k**	Call subroutine	2	10 0kkk kkkk kkkk			
CLRWDT	**-**	Clear Watchdog Timer	1	00 0000 0110 0100		$\overline{TO}$,$\overline{PD}$	
GOTO	**k**	Go to address	2	10 1kkk kkkk kkkk			
IORLW	**k**	Inclusive OR literal with W	1	11 1000 kkkk kkkk		Z	
MOVLW	**k**	Move literal to W	1	11 00xx kkkk kkkk			
RETFIE	**-**	Return from interrupt	2	00 0000 0000 1001			
RETLW	**k**	Return with literal in W	2	11 01xx kkkk kkkk			
RETURN	**-**	Return from Subroutine	2	00 0000 0000 1000			
SLEEP	**-**	Go into Standby mode	1	00 0000 0110 0011		$\overline{TO}$,$\overline{PD}$	
SUBLW	**k**	Subtract W from literal	1	11 110x kkkk kkkk		C,DC,Z	
XORLW	**k**	Exclusive OR literal with W	1	11 1010 kkkk kkkk		Z	

Note 1: When an I/O register is modified as a function of itself (e.g., `MOVF PORTB, 1`), the value used will be that value present on the pins themselves. For example, if the data latch is '1' for a pin configured as input and is driven low by an external device, the data will be written back with a '0'.

2: If this instruction is executed on the TMR0 register (and, where applicable, d = 1), the prescaler will be cleared if assigned to the Timer0 Module.

3: If Program Counter (PC) is modified or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a `NOP`.

13.1 Instruction Descriptions

ADDLW	Add Literal and W
Syntax:	[*label*] ADDLW k
Operands:	$0 \le k \le 255$
Operation:	(W) + k → (W)
Status Affected:	C, DC, Z
Description:	The contents of the W register are added to the eight bit literal 'k' and the result is placed in the W register.

ADDWF	Add W and f
Syntax:	[*label*] ADDWF f,d
Operands:	$0 \le f \le 127$ $d \in [0,1]$
Operation:	(W) + (f) → (destination)
Status Affected:	C, DC, Z
Description:	Add the contents of the W register with register 'f'. If 'd' is 0, the result is stored in the W register. If 'd' is 1, the result is stored back in register 'f'.

ANDLW	AND Literal with W
Syntax:	[*label*] ANDLW k
Operands:	$0 \le k \le 255$
Operation:	(W) .AND. (k) → (W)
Status Affected:	Z
Description:	The contents of W register are AND'ed with the eight bit literal 'k'. The result is placed in the W register.

ANDWF	AND W with f
Syntax:	[*label*] ANDWF f,d
Operands:	$0 \le f \le 127$ $d \in [0,1]$
Operation:	(W) .AND. (f) → (destination)
Status Affected:	Z
Description:	AND the W register with register 'f'. If 'd' is 0, the result is stored in the W register. If 'd' is 1, the result is stored back in register 'f'.

BCF	Bit Clear f
Syntax:	[*label*] BCF f,b
Operands:	$0 \le f \le 127$ $0 \le b \le 7$
Operation:	0 → (f<b>)
Status Affected:	None
Description:	Bit 'b' in register 'f' is cleared.

BSF	Bit Set f
Syntax:	[*label*] BSF f,b
Operands:	$0 \le f \le 127$ $0 \le b \le 7$
Operation:	1 → (f<b>)
Status Affected:	None
Description:	Bit 'b' in register 'f' is set.

15.1 DC Characteristics: PIC16C717/770/771 (Commercial, Industrial, Extended) PIC16LC717/770/771 (Commercial, Industrial, Extended) (Continued)

PIC16LC717/770/771			**Standard Operating Conditions (unless otherwise stated)** Operating temperature 0°C ≤ TA ≤ +70°C for commercial -40°C ≤ TA ≤ +85°C for industrial -40°C ≤ TA ≤ +125°C for extended				
PIC16C717/770/771			**Standard Operating Conditions (unless otherwise stated)** Operating temperature 0°C ≤ TA ≤ +70°C for commercial -40°C ≤ TA ≤ +85°C for industrial -40°C ≤ TA ≤ +125°C for extended				
Param. No.	**Sym**	**Characteristic**	**Min**	**Typ†**	**Max**	**Units**	**Conditions**
	IDD	**Supply Current(2)**					
D010D		**PIC16LC7XX**		1.0	2.0	mA	FOSC = 10 MHz, VDD = 3V, -40°C to 85°C
D010E					3.0		FOSC = 10 MHz, VDD = 3V, -40°C to 125°C
D010G				0.36	1.0	mA	FOSC = 4 MHz, VDD = 2.5V, -40°C to 125°C
D010K				11	45	µA	FOSC = 32 kHz, VDD = 2.5V, -40°C to 125°C
	IDD	**Supply Current(2)**					
D010		**PIC16C7XX**		4.0	7.5	mA	FOSC = 20 MHz, VDD = 5.5V, -40°C to 85°C
D010A					12.0		FOSC = 20 MHz, VDD = 5.5V, -40°C to 125°C
D010B				2.5	5.0	mA	FOSC = 20 MHz, VDD = 4V, -40°C to 85°C
D010C					6.0		FOSC = 20 MHz, VDD = 4V, -40°C to 125°C
D010F				0.55	1.5	mA	FOSC = 4 MHz, VDD = 4V, -40°C to 125°C
D010H				30	80	µA	FOSC = 32 kHz, VDD = 4V, -40°C to 85°C
D010J					95		FOSC = 32 kHz, VDD = 4V, -40°C to 125°C

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: This is the limit to which VDD can be lowered without losing RAM data.

2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.
The test conditions for all IDD measurements in active Operation mode are:
OSC1 = external square wave, from rail to rail; all I/O pins tristated, pulled to VDD
$\overline{MCLR}$ = VDD; WDT enabled/disabled as specified.

15.5 Master SSP SPI Mode Timing Waveforms and Requirements

FIGURE 15-18: SPI MASTER MODE TIMING (CKE = 0)

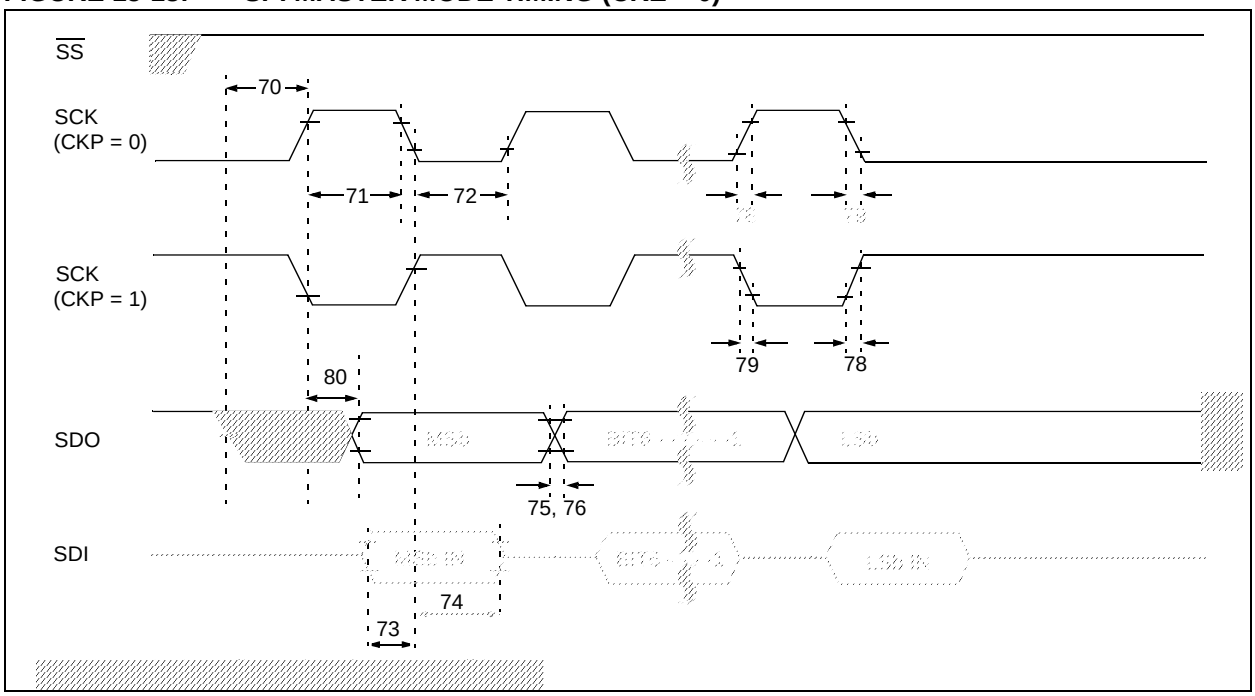


TABLE 15-17: SPI MODE REQUIREMENTS (MASTER MODE, CKE = 0)

Param. No.	Symbol	Characteristic		Min	Typ†	Max	Units	Conditions
70*	TssL2scH, TssL2scL	$\overline{SS}$↓ to SCK↓ or SCK↑ input		TCY	—	—	ns	
71*	TscH	SCK input high time (Slave mode)	Continuous	1.25TCY + 30	—	—	ns	
71A*			Single Byte	40	—	—	ns	**Note 1**
72*	TscL	SCK input low time (Slave mode)	Continuous	1.25TCY + 30	—	—	ns	
72A*			Single Byte	40	—	—	ns	**Note 1**
73*	TdiV2scH, TdiV2scL	Setup time of SDI data input to SCK edge		100	—	—	ns	
73A*	TB2B	Last clock edge of Byte1 to the 1st clock edge of Byte2		1.5TCY + 40	—	—	ns	**Note 1**
74*	TscH2diL, TscL2diL	Hold time of SDI data input to SCK edge		100	—	—	ns	
75*	TdoR	SDO data output rise time	PIC16**C**XXX	—	10	25	ns	
			PIC16**LC**XXX	—	20	45	ns	
76*	TdoF	SDO data output fall time		—	10	25	ns	
78*	TscR	SCK output rise time (Master mode)	PIC16**C**XXX	—	10	25	ns	
			PIC16**LC**XXX	—	20	45	ns	
79*	TscF	SCK output fall time (Master mode)		—	10	25	ns	
80*	TscH2doV, TscL2doV	SDO data output valid after SCK edge	PIC16**C**XXX	—	—	50	ns	
			PIC16**LC**XXX	—	—	100	ns	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Specification 73A is only required if specifications 71A and 72A are used.

FIGURE 16-4: TYPICAL IDD VS. FOSC OVER VDD (XT MODE)

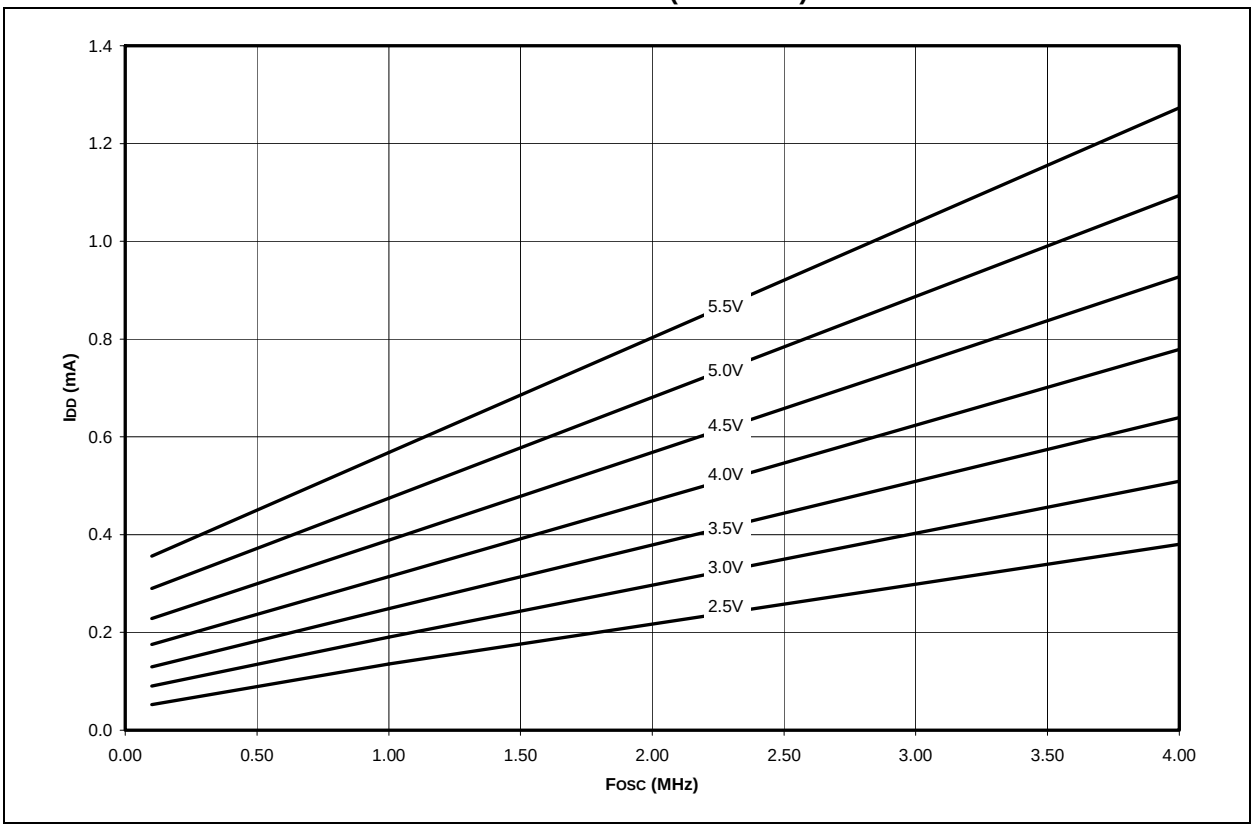


FIGURE 16-5: MAXIMUM IDD VS. FOSC OVER VDD (LP MODE)

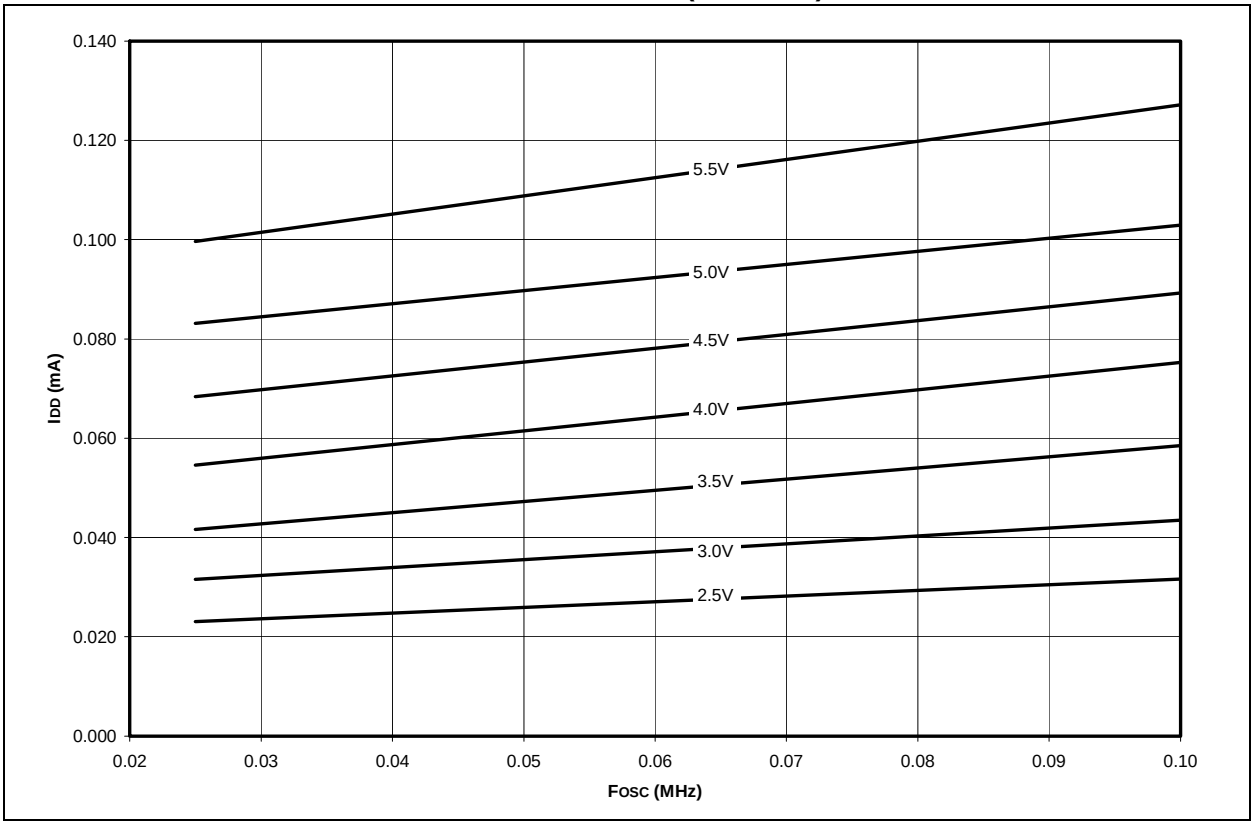


FIGURE 16-10: TYPICAL IDD VS. FOSC OVER VDD (ER MODE)

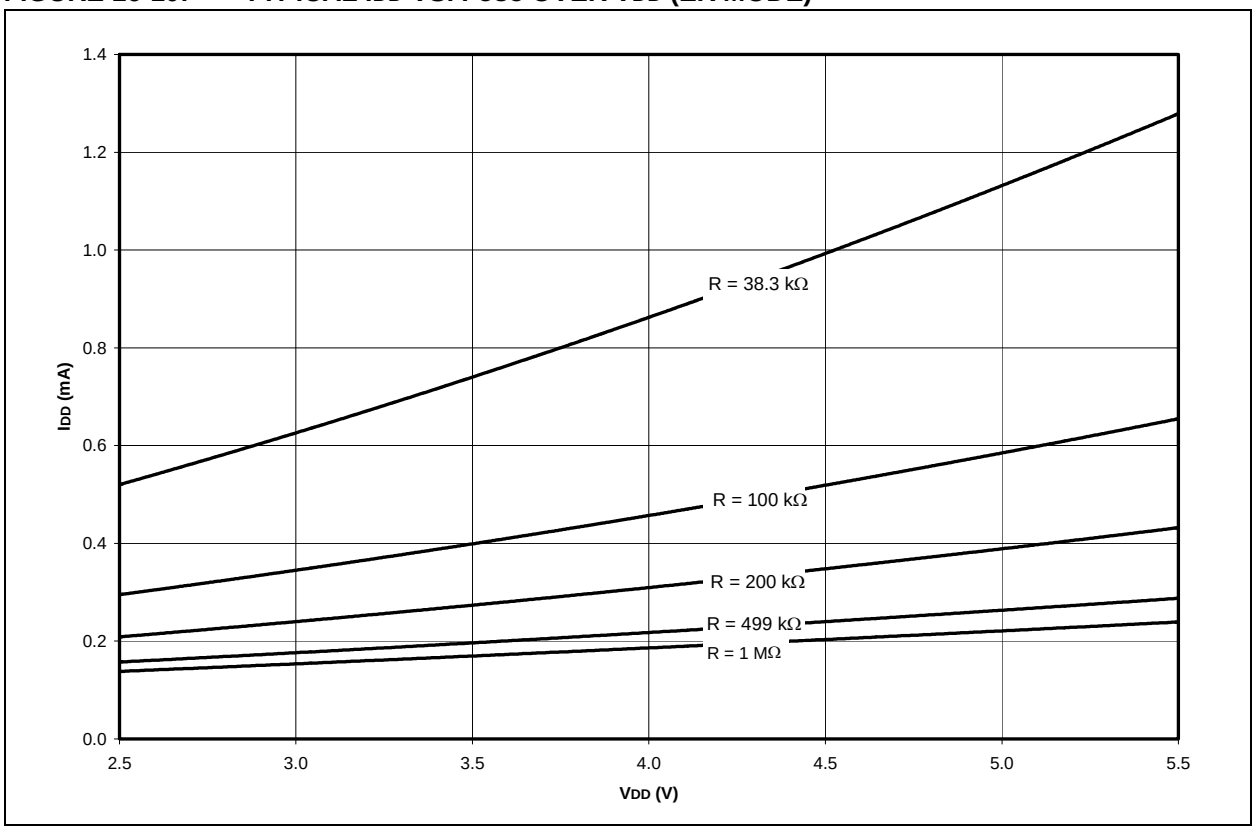


FIGURE 16-11: TYPICAL FOSC VS. VDD (ER MODE)